

High Current, High Frequency, Power Inductors

Flat-Pac™ FP1007R6 Series



Description

- Halogen free, lead free, RoHS compliant
- 125°C Maximum total temperature operation
- 10.5 x 8.0 x 7.0mm Maximum surface mount package
- Ferrite core material
- Controlled DCR tolerance for sensing circuits
- Inductance Range from 150nH to 470nH
- Current range from 23.5 to 75 Amps
- Frequency range up to 2MHz

Applications

- Multi-phase regulators
- Voltage Regulator Modules (VRMs)
- Desktop and server VRMs and EVRDs
- Notebook regulators
- Data networking and storage systems
- Graphics cards and battery power systems
- Point-of-Load modules
- DCR Sensing

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant

Packaging

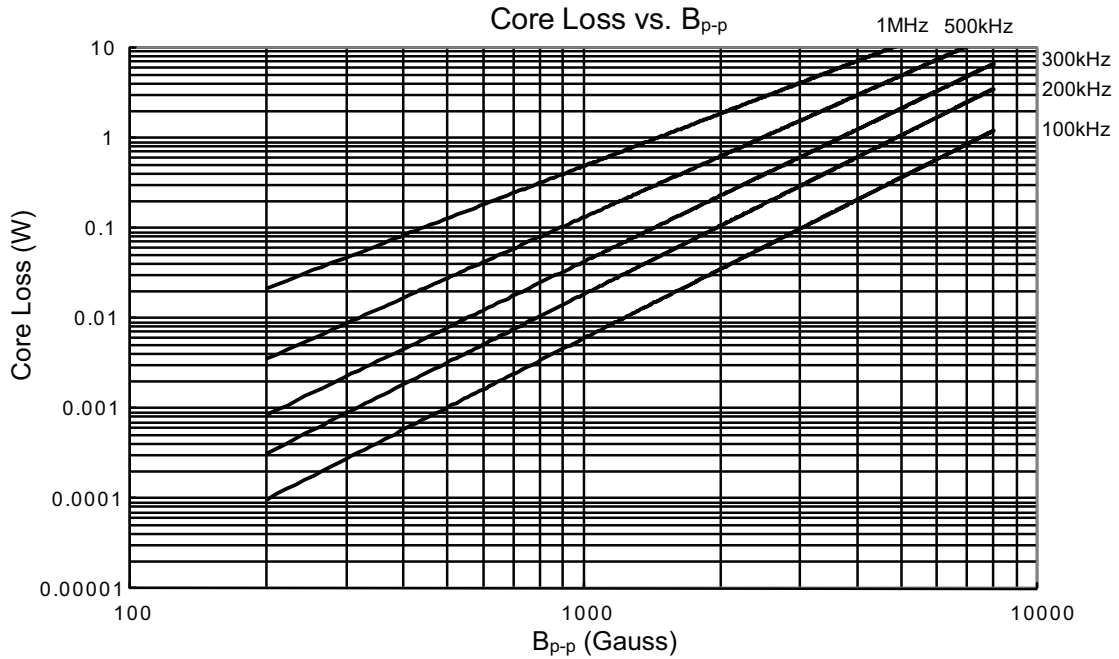
- Supplied in tape-and-reel packaging, 700 parts per 13 inch diameter reel

Product Specifications							
Part Number ⁷	OCL ¹ ±10% (nH)	FLL ² Min. (nH)	I _{rms} ³ (Amps)	I _{sat} ¹⁴ @25°C (Amps)	I _{sat} ²⁵ @100°C (Amps)	DCR @20°C (mΩ)	K-Factor ⁶
FP1007R6-R15-R	150	108	61	75.0	60.0	0.29 ± 5%	348.8
FP1007R6-R18-R	180	129		60.0	50.0		
FP1007R6-R22-R	220	158		50.0	40.0		
FP1007R6-R27-R	270	194		41.0	33.0		
FP1007R6-R33-R	330	237		33.0	26.5		
FP1007R6-R39-R	390	280		28.0	22.5		
FP1007R6-R47-R	470	338		23.5	19.0		

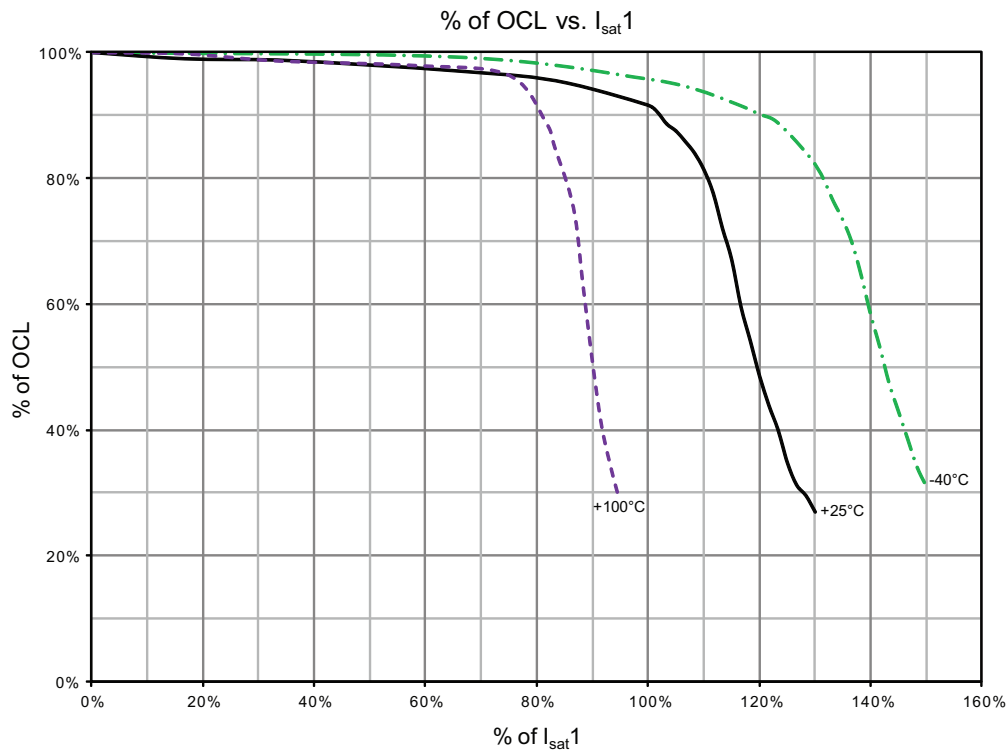
1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0Acd
 2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V_{rms}, I_{sat}1
 3. I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
 4. I_{sat}1: Peak current for approximately 20% rolloff at +25°C.

5. I_{sat}2: Peak current for approximately 20% rolloff at +100°C.
 6. K-factor: Used to determine B_{p-p} for core loss (see graph).
 $B_{p-p} = K * L * \Delta I * 10^{-3}$. B_{p-p}:(Gauss), K: (K-factor from table), L: (Inductance in nH), ΔI (peak-to-peak ripple current in Amps).
 7. Part Number Definition: FP1007R6-Rxx-R
 FP1007R6 = Product code and size
 Rxx= Inductance value in uH, R = decimal point
 -R suffix = RoHS compliant

Core Loss



Inductance Characteristics



Solder Reflow Profile

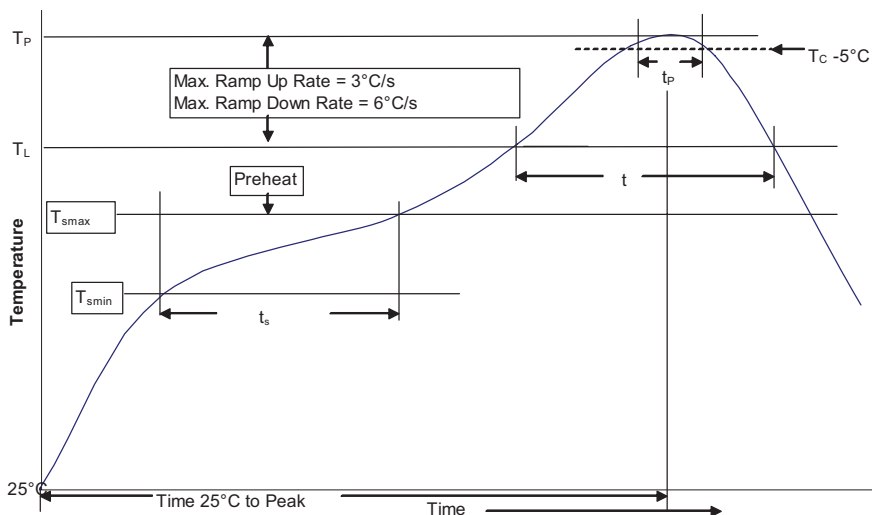


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm^3 <350	Volume mm^3 ≥ 350
<2.5mm	235°C	220°C
$\geq 2.5\text{mm}$	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm^3 <350	Volume mm^3 350 - 2000	Volume mm^3 >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
$> 2.5\text{mm}$	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T_{smin})	100°C	150°C
• Temperature max. (T_{smax})	150°C	200°C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_p	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L)	183°C	217°C
Time at liquidous (t_l)	60-150 Seconds	60-150 Seconds
Peak package body temperature (T_p)*	Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)	20 Seconds**	30 Seconds**
Average ramp-down rate (T_p to T_{smax})	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

North America

Cooper Electronic Technologies
1225 Broken Sound Parkway NW
Boca Raton, FL 33487-3533
Tel: 1-561-998-4100
Fax: 1-561-241-6640
Toll Free: 1-888-414-2645

Cooper Bussmann
P.O. Box 14460
St. Louis, MO 63178-4460
Tel: 1-636-394-2877
Fax: 1-636-527-1607

Europe

Cooper Electronic Technologies
Cooper (UK) Limited
Burton-on-the-Wolds
Leicestershire • LE12 5TH UK
Tel: +44 (0) 1509 882 737
Fax: +44 (0) 1509 882 786

Cooper Electronic Technologies
Avda. Santa Eulalia, 290
08223
Terrassa, (Barcelona), Spain
Tel: +34 937 362 812
+34 937 362 813
Fax: +34 937 362 719

Asia Pacific

Cooper Electronic Technologies
1 Jalan Kilang Timor
#06-01 Pacific Tech Centre
Singapore 159303
Tel: +65 278 6151
Fax: +65 270 4160

The only controlled copy of this Data Sheet is the electronic read-only version located on the Cooper Bussmann Network Drive. All other copies of this document are by definition uncontrolled. This bulletin is intended to clearly present comprehensive product data and provide technical information that will help the end user with design applications. Cooper Bussmann reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Cooper Bussmann also reserves the right to change or update, without notice, any technical information contained in this bulletin. Once a product has been selected, it should be tested by the user in all possible applications.

Life Support Policy: Cooper Bussmann does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.